

27C256

256K CMOS UV Erasable PROM (32K × 8)

Product Specification

Military Application Specific Products

DESCRIPTION

The Signetics 27C256 CMOS EPROMs are 256K-Bit 5V only memories organized as 32,768 words of 8 bits. They employ advanced CMOS circuitry for systems requiring low-power, high-performance speeds and immunity to noise. The 27C256 has a non-multiplexed addressing interface and is plug compatible with the industry standard 27256.

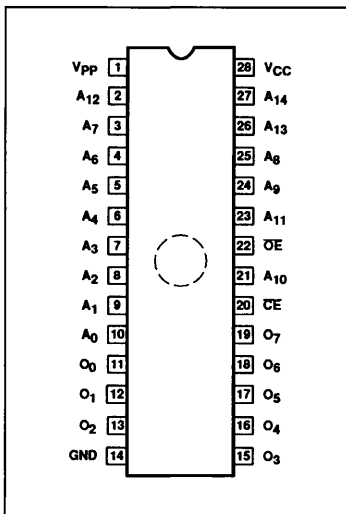
The 27C256 achieves both high-performance and low power consumption (10mA active current maximum, CMOS inputs), making them ideal for high-performance, portable equipment.

It is programmed with standard EPROM programmers and the intelligent programming algorithm may be utilized.

FEATURES

- CMOS/NMOS microcontroller and microprocessor compatible
 - Universal 28- or 32-Pin memory site, 2-line control
- Low power consumption
- Noise Immunity features
 - $\pm 10\%$ V_{CC} tolerance
 - Maximum latch-up Immunity through epitaxial processing
- Fast, reliable intelligent programming
 - 12.5V V_{PP} , HCMOS 11-E compatible

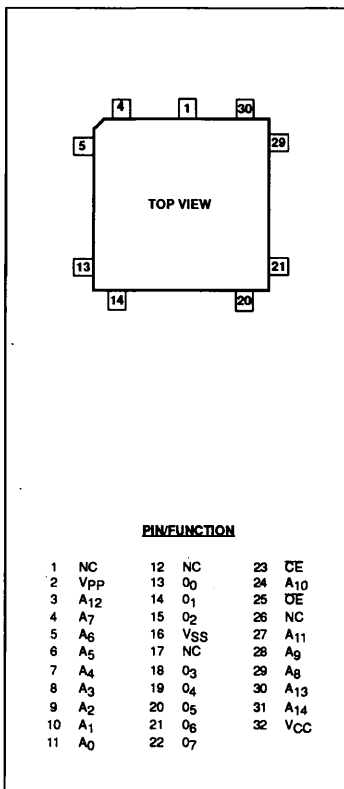
CERDIP PIN CONFIGURATION



PIN NAMES

$A_0 - A_{14}$	Addresses
$O_0 - O_7$	Outputs
\overline{OE}	Output Enable
\overline{CE}	Chip Enable
GND	Ground
V_{PP}	Program Voltage
V_{CC}	Power Supply

LLCC PIN CONFIGURATION



PIN/FUNCTION

1	NC	12	NC	23	\overline{CE}
2	V_{PP}	13	O_0	24	A_{10}
3	A_{12}	14	O_1	25	\overline{OE}
4	A_7	15	O_2	26	NC
5	A_6	16	VSS	27	A_{11}
6	A_5	17	NC	28	A_9
7	A_4	18	O_3	29	A_8
8	A_3	19	O_4	30	A_{13}
9	A_2	20	O_5	31	A_{14}
10	A_1	21	O_6	32	V_{CC}
11	A_0	22	O_7		

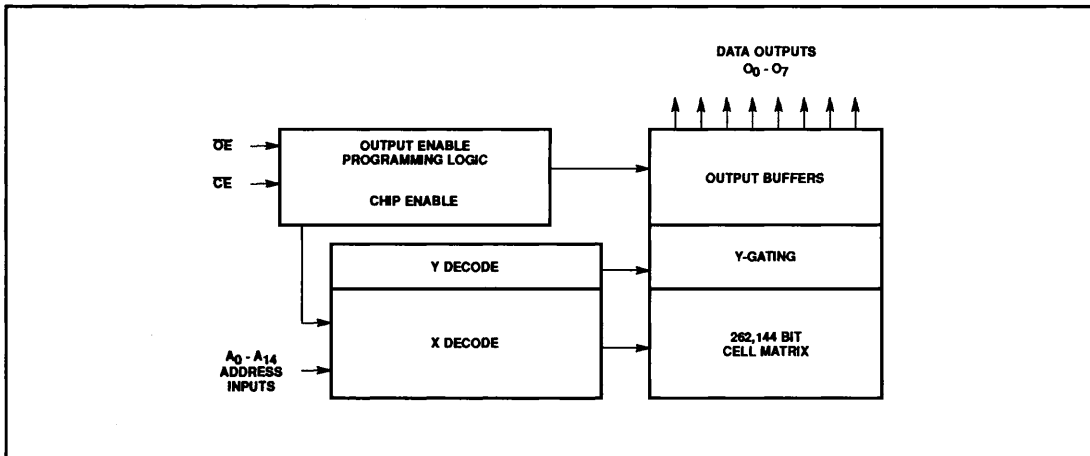
ORDERING INFORMATION

PACKAGES	ORDER CODE		
	150ns	200ns	250ns
28-Pin Ceramic DIP w/Quartz Window	27C256/BXA-15	27C256/BXA-20	27C256/BXA-25
28-Pin Ceramic DIP w/o Quartz Window ¹	27C256/BXA-15 OT	27C256/BXA-20 OT	27C256/BXA-25 OT
32-Pin Rectangular LLCC w/Quartz Window	27C256/BUA-15	27C256/BUA-20	27C256/BUA-25

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BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS²

SYMBOL	PARAMETER	RATING	UNIT
T _{STG}	Storage temperature range	-65 to +150	°C
V _I , V _O	Voltage on any pin with respect to ground	-2.0 to V _{CC} +7V	V
V _I	Voltage on CE Pin with respect to ground	-2.0 to +13.5	V
V _{PP}	Supply voltage with respect to ground during programming	-2.0 to 14.0	V

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMITS			UNIT
		Min	Nom	Max	
V _{CC}	Supply voltage	4.5	5.0	5.5	V
V _{IH} ³	High-level input voltage	2.0		V _{CC} + 0.5 ¹²	V
V _{IH} ³	High-level input voltage CMOS V _{PP} = V _{CC}	V _{CC} - 0.2		V _{CC} + 0.2 ¹²	V
V _{IL} ³	Low-level input voltage V _{PP} = V _{CC}	-0.5 ¹²		0.8	V
V _{IL} ³	Low-level input voltage CMOS V _{PP} = V _{CC}	-0.2 ¹²		0.2	V
I _{OH}	High-level output current			-400	µA
I _{OL}	Low-level output current			2.1	mA
V _{PP}	V _{PP} read voltage ⁵	V _{CC} - 0.7		V _{CC}	V
T _A	Operating temperature range	-55		+125	°C

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READ OPERATION DC CHARACTERISTICS -55 °C ≤ T_A ≤ +125°C, V_{CC} = 5V ± 10%

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS			UNIT
			Min	Typ ⁴	Max	
I _{LH}	Input leakage current	V _I = V _{CC} = Max		0.01	+1.0	μA
I _{LIL}		V _I = 0.0V			-1.0	μA
I _{OIH}	Output leakage current	V _I = V _{CC} = Max		0.01	+1.0	μA
I _{OIL}		V _I = 0.0V			-1.0	μA
I _{CC} TTL ^{6,8}	Operating current TTL inputs	CE = OE - V _{IL} , V _{PP} = V _{CC} - Max O ₀ - O ₇ = 0mA			30	mA
I _{CC} CMOS ^{6,8}	Operating current CMOS inputs	CE = OE - V _{IL} , V _{PP} = V _{CC} - Max O ₀ - O ₇ = 0mA			10	mA
I _{SB} TTL ⁸	Standby current TTL inputs	CE = V _{IH}			2	mA
I _{SB} CMOS ⁵	Standby current CMOS inputs	CE = V _{IH}			100	μA
I _{PP} ⁸	V _{PP} read current	V _{PP} = V _{CC} = Max			200	μA
V _{IL} ⁹	Input Low voltage (TTL) Input Low voltage (CMOS)	V _{PP} = V _{CC}	-0.5 ¹⁰ -0.2 ¹⁰		0.8 0.2	V V
V _{IH} ⁹	Input High voltage (TTL) Input High voltage (CMOS)	V _{PP} = V _{CC}	2.0 V _{CC} -0.2		V _{CC} + 0.5 ¹⁰ V _{CC} + 0.2 ¹⁰	V V
V _{OL}	Output Low voltage	I _{OL} = Max			0.45	V
V _{OH}	Output High voltage	I _{OH} = Max	2.4			V
I _{OS} ⁷	Output short-circuit current				-100	mA

CAPACITANCE T_A = 25°C, f = 1.0MHz

SYMBOL	PARAMETER	TEST CONDITIONS	MAX	UNIT
C _I ¹⁰	Address/control capacitance	V _I = 0V	6	pF
C _O ¹⁰	Output capacitance	V _O = 0V	12	pF

READ MODES

MODE	PINS			
	CE (20)	OE (22)	V _{PP} (1)	OUTPUTS (11-13, 15-19)
Read	V _{IL}	V _{IL}	V _{CC}	D _O
Output disable	V _{IL}	V _{IH}	V _{CC}	Hi-Z
Standby	V _{IH}	X	V _{CC}	Hi-Z

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READ MODE

The 27C256 has two control functions, both of which must be logically active in order to obtain data at the outputs. Chip Enable (CE) is the power control and should be used for device selection. Output Enable (OE) is the output control and should be used to gate data from the output pins, independent of device selection. Assuming that addresses are stable, the address access time (t_{ACC}) is equal to the delay from CE to output (t_{CE}). Data is available at the outputs after a delay of t_{OE} from the falling edge of OE, assuming that CE has been low and addresses have been stable for at least $t_{ACC}-t_{OE}$.

100µA. The device is placed in the Standby mode when Pin 20 is in the High state. When in the Standby mode, the outputs are in a high-impedance state, independent of the OE input.

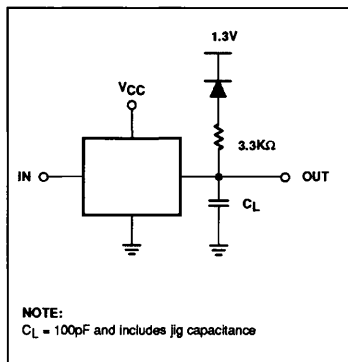
STANDBY MODE

The 27C256 has a Standby mode which reduces the maximum CMOS V current to

READ OPERATION - AC CHARACTERISTICS $-55^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$, $4.5\text{V} \leq V_{CC} \leq 5.5\text{V}^{12}$

SYMBOL	PARAMETER	27C256-15		27C256-20		27C256-25		UNIT
		Min	Max	Min	Max	Min	Max	
t_{ACC}	Address to output delay		150		200		250	ns
t_{CE}	CE to output delay		150		200		250	ns
t_{OE}	OE to output delay		65		75		100	ns
t_{OP}^{10}	OE or CE High to output Hi-Z		45		55		60	ns
t_{OH}^{10}	Output hold from addresses, CE or OE change - whichever is first	0		0		0		ns

AC TESTING LOAD CIRCUIT



edges of Chip Enable. The magnitude of these transient current peaks is dependent on the output capacitive and inductive loading of the devices. The associated transient voltage peaks can be suppressed by complying with Two-Line Control and by properly selected decoupling capacitors.

It is recommended that a 0.1µF ceramic capacitor be used on every device between V_{CC} and GND. This should be a high frequency capacitor of low inherent inductance and should be placed as close to the device as possible. In addition, a 4.7µF bulk electrolytic capacitor should be used between V_{CC} and GND for every eight devices. The bulk capacitor should be located near where the power supply is connected to the array. The purpose of the bulk capacitor is to overcome the voltage drop caused by the inductive effects of PC board traces.

cent lamps have wavelengths in the 3000-4000 Å Range. Data shows that constant exposure to room level fluorescent lighting could erase the typical 27C256 in approximately three years, while it would take approximately one week to cause erasure when exposed to direct sunlight. If the 27C256 is to be exposed to these types of lighting conditions for extended periods of time, opaque labels should be placed over the window to prevent unintentional erasure.

The recommended erasure procedure for the 27C256 is exposure to shortwave ultraviolet light which has a wavelength of 2537 Angstroms (Å). The integrated dose (i.e., UV intensity x exposure time) for erasure should be a minimum of 15Wsec/cm². The erasure time with this dosage is approximately 15 to 20 minutes using an ultraviolet lamp with a 12,000µW/cm² power rating. The 27C256 should be placed within one inch of the lamp tubes during erasure. The maximum integrated dose a 27C256 can be exposed to without damage is 7258W/cm² (1 week @ 1200µW/cm²). Exposure of these CMOS EPROMs to high intensity UV light for longer periods may cause permanent damage.

SYSTEM CONSIDERATIONS

The power switching characteristics of CMOS EPROMs require careful decoupling of the devices. The supply current, I_{CC} , has three segments that are of interest to the system designer - the standby current level, the active current level, and the transient current peaks that are produced by the falling and rising

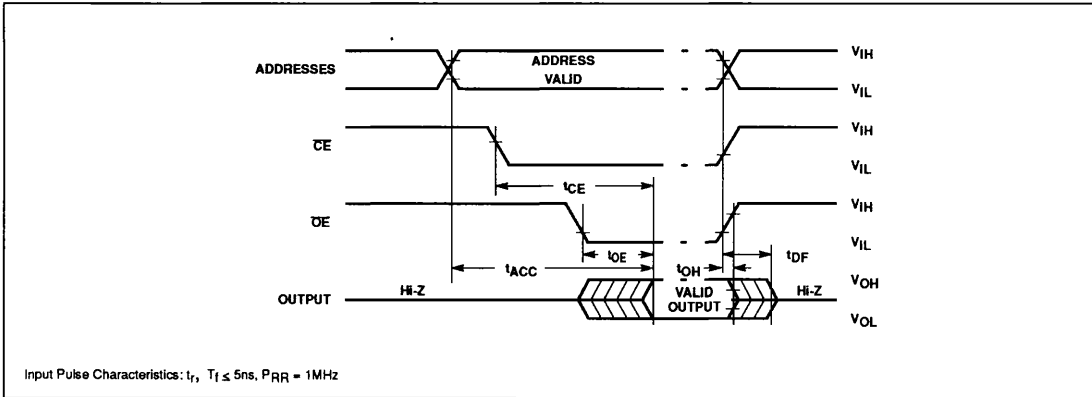
ERASURE CHARACTERISTICS

The erasure characteristics of the 27C256 are such that erasure begins to occur upon exposure to light with wavelengths shorter than approximately 4000 Angstroms (Å). It should be noted that sunlight and certain types of fluores-

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AC WAVEFORMS



PROGRAMMING MODES

MODES	PINS						
	CE (20)	OE (22)	A ₉ (24)	A ₀ (10)	V _{PP} (1)	V _{CC} (28)	OUTPUTS (11-13, 15-19)
Intelligent programming	V _{IL}	V _{IH}	X ¹³	X ¹³	V _{PP}	6.0V ¹⁶	D ₁
Program verify	V _{IH}	V _{IL}	X ¹³	X ¹³	V _{PP}	6.0V ¹⁶	D ₂
Program inhibit	V _{IH}	V _{IH}	X ¹³	X ¹³	V _{PP}	6.0V ¹⁶	Hi-Z
Intelligent identifier-manufacturer ¹⁵	V _{IL}	V _{IL}	V _{IH} ¹⁴	V _{IL}	V _{CC}	V _{CC}	15H
Intelligent identifier ¹⁵	V _{IL}	V _{IL}	V _{IH} ¹⁴	V _{IH}	V _{CC}	V _{CC}	8CH

CMOS NOISE CHARACTERISTICS

Special epitaphial processing techniques have enabled Signetics to build CMOS with features adding to system reliability. These include Input/Output protection to latch-up. Each of the data and address pins will not latch-up with currents up to 100mA and voltages from -1V to V_{CC} + 1V.

Additionally, the V_{PP} (Programming) pin is designed to resist latch-up to the 14V maximum device limit.

PROGRAMMING

Caution: Exceeding 14.0V on V_{PP} Pin may permanently damage the 27C256.

Initially, and after each erasure, all bits of the 27C256 are in the "1" state. Data is introduced by selectively programming "0" into the desired bit location. Although only "0" will be programmed, both "1" and "0" can be present in the data word. The only way to change an "0" to a "1" is by ultraviolet light erasure.

The 27C256 is in the programming mode when the V_{PP} input is at 12.5V and CE is at TTL-Low. The data to be programmed is applied 8 bits in parallel to the data output pins. The levels required for the address and data inputs are TTL.

INTELLIGENT PROGRAMMING™ ALGORITHM

The 27C256 intelligent programming algorithms rapidly program Signetics CMOS EPROMs using an efficient and reliable method particularly suited to the production programming environment. Typical programming times for individual devices are on the order of five minutes. Actual programming times may vary due to differences in programming equipment.

Programming reliability is also ensured as the incremental program margin of each byte is continually monitored to determine when it has been successfully programmed. A flow-chart of the 27C256 intelligent program algorithm is shown in Figure 1.

The intelligent programming algorithm utilizes two different pulse types: initial and overprogram. The duration of the initial CE pulse(s) is 1ms, which will then be followed by a longer overprogram pulse of length 3Xms. X is a duration counter and is equal to the number of the initial 2ms pulses applied to a particular 27C256 location, before a correct verify occurs. Up to 25 1ms pulses per byte are provided for before the overprogram is applied.

The entire sequence of program pulses and byte verifications is performed at V_{CC} = 6.0V and V_{PP} = 12.5V.

When the intelligent programming cycle has been completed, all bytes should be compared to the original data with V_{CC} = 5.0V.

PROGRAM INHIBIT

Programming of multiple 27C256 EPROMs in parallel with different data is easily accomplished by using the Program Inhibit mode. A high-level CE input inhibits other 27C256 EPROMs from being programmed.

Except for OE or CE, all inputs of the parallel 27C256s may be common. A TTL low-level pulse applied to the CE or ALE/CE input with V_{PP} at 12.5V will program the selected 27C256.

VERIFY

A verify (read) should be performed on the programmed bits to determine that they have been correctly programmed. The verify is performed with OE at V_{IL} and CE at V_{IH} and V_{PP} at 12.5V. Data should be verified a minimum of T_{OE}V after the falling edge of OE.

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INTELLIGENT IDENTIFIER MODE

The intelligent identifier mode allows the reading out of a binary code from an EPROM that will identify its manufacturer and type. This mode is intended for use by programming equipment for the purpose of automatically

matching the device to be programmed with its corresponding programming algorithm. This mode is functional in the $25^{\circ}\text{C} \pm 5^{\circ}\text{C}$ ambient temperature range that is required when programming the 27C256.

To activate this mode the programming equipment must force 11.5V to 12.5V on address line A_9 of the 27C256. Two bytes may then be sequenced from the device outputs by toggling address line A_0 from V_{IL} to V_{IH} . All other address lines must be held at V_{IL} during intelligent identifier mode.

INTELLIGENT PROGRAMMING ALGORITHM DC PROGRAMMING CHARACTERISTICS

$T_A = 25^{\circ}\text{C} \pm 5^{\circ}\text{C}$, $V_{CC} = 6.0\text{V} \pm 0.25\text{V}$, $V_{PP} = 12.5\text{V} \pm 0.5\text{V}$

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS		UNIT
			Min	Max	
I_{IH}	Input current (all inputs)	$V_{IN} = V_{IL}$ or V_{IH}		1.0	μA
V_{IL}	Input Low level (all inputs)		-0.1	0.8	V
V_{IH}	Input High level		2.0	$V_{CC} + 0.5$	V
V_{OL}	Output Low voltage during verify	$I_{OL} = 2.1\text{mA}$		0.45	V
V_{OH}	Output High voltage during verify	$I_{OH} = -2.5\text{mA}$	3.5		V
I_{CC2}	V_{CC} supply current	$O_0 - O_7 = 0\text{mA}$		30	mA
I_{PP2}	V_{PP} supply current (program)	$\overline{CE} = V_{IL}$		50	mA

AC PROGRAMMING CHARACTERISTICS

SYMBOL	PARAMETER	TEST CONDITIONS ¹⁷	LIMITS			UNIT
			Min	Typ	Max	
t_{CES}	\overline{CE} setup time		2			μs
t_{AS}	Address setup time		2			μs
t_{OES}	\overline{OE} setup time		2			μs
t_{DS}	Data setup time		2			μs
t_{AH}	Address hold time		0			μs
t_{DH}	Data hold time		2			μs
t_{DFP}^{20}	\overline{OE} High to output float delay		0		130	μs
t_{VPS}	V_{PP} setup time		2			μs
t_{VCS}	V_{CC} setup time		2			μs
t_{PW}	\overline{CE} initial program pulse width	(See note 18)	0.95	1.0	1.05	ms
t_{OPW}	\overline{CE} overprogram pulse width	(See note 19)	2.85		78.75	ms
t_{OE}	Data valid from \overline{OE}				150	ns

NOTES:

- Erase characteristics do not apply for one time programming (OT).
- Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
- Minimum DC input voltage is -0.5V. During transitions, the inputs may undershoot to -2.0V for periods less than 20ns.
- Typical limits are at $V_{CC} = 5\text{V}$, $T_A = +25^{\circ}\text{C}$.
- Other inputs can have any value within spec.
- Maximum active power usage is the sum $I_{PP} + I_{CC}$ and is measured at 5MHz.
- Output shorted for no more than one second. No more than one output shorted at a time. I_{OS} is sampled but not 100% tested.
- V_{PP} may be one diode voltage drop below V_{CC} . It may be connected directly to V_{CC} . Also, V_{CC} must be applied simultaneously or before V_{PP} and removed simultaneously or after V_{PP} .
- TTL inputs: spec TTL at V_{IH} , V_{IL} levels. CMOS inputs: $\text{GND} \pm 0.2\text{V}$ to $V_{CC} \pm 0.2\text{V}$.
- Guaranteed, but not tested.
- X can be V_{IH} or V_{IL} .
- AC characteristics tested at $V_{IH} = 2.4\text{V}$ and $V_{IL} = 0.45\text{V}$. Timing measurements made at $V_{OL} = 0.8\text{V}$ and $V_{OH} = 2.0\text{V}$.
- X can be V_{IL} or V_{IH} .
- $V_H = 12.0\text{V} \pm 0.5\text{V}$.
- $A_1 - A_9, A_{10} - A_{12} = V_{IL}$.

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- 16. $V_{CC} = 6.0V \pm 0.25V$.
- 17. AC Conditions of Test:
 - Input Rise and Fall Times (100% to 90%): 20ns
 - Input Pulse Levels: 0.45V to 2.4V
 - Input Timing Reference Level: 0.8V to 2.0V
 - Output Timing Reference Level: 0.8V to 2.0V
- 18. Initial Program Pulse width tolerance is 1msec \pm 5%.
- 19. The length of the overprogram pulse may vary from 2.85msec to 78.75msec as a function of the iteration counter value X.
- 20. This parameter is only sampled and is not 100% tested. Output Float is defined as the point where data is no longer driven (see Timing Diagram).

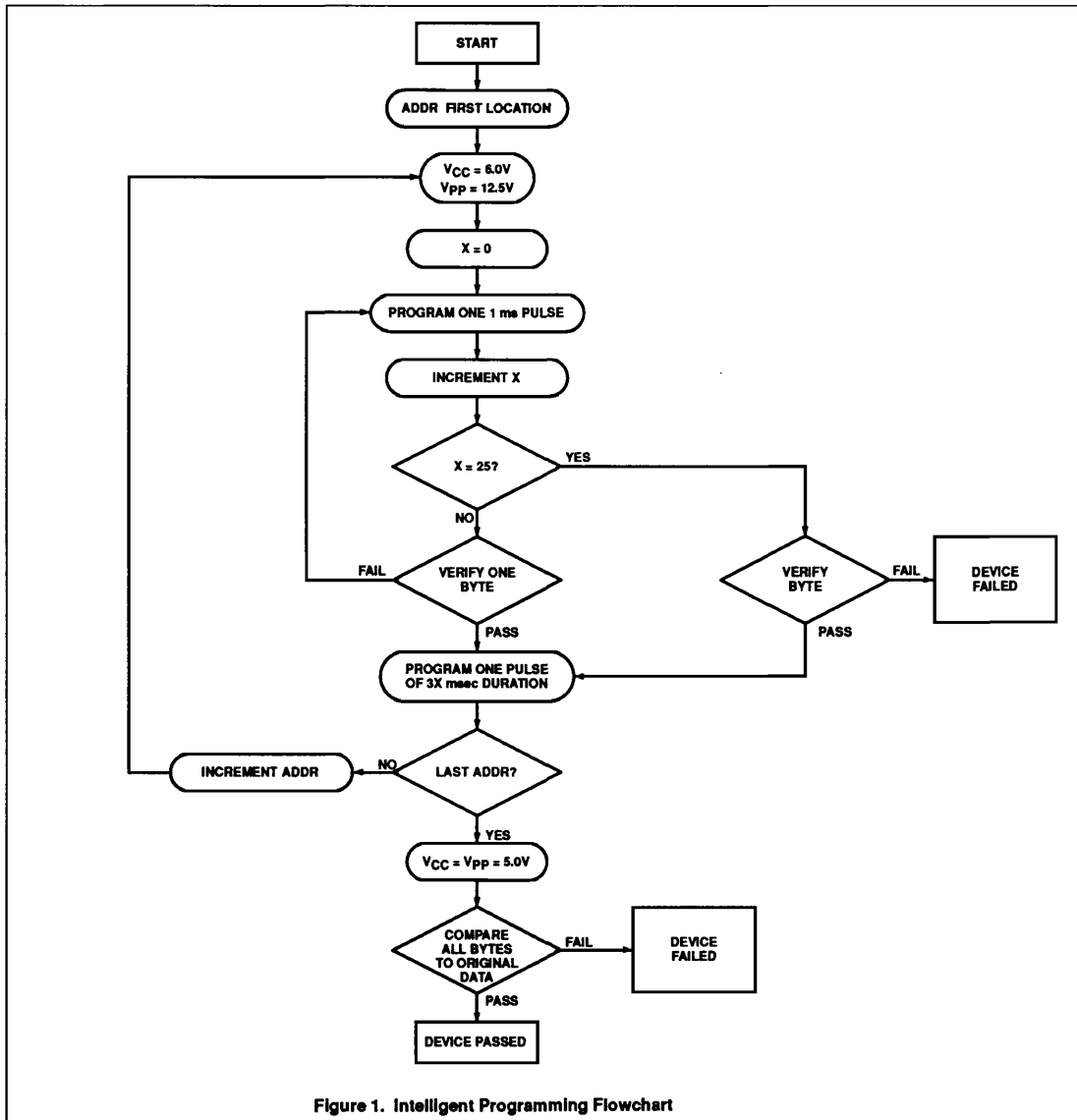


Figure 1. Intelligent Programming Flowchart

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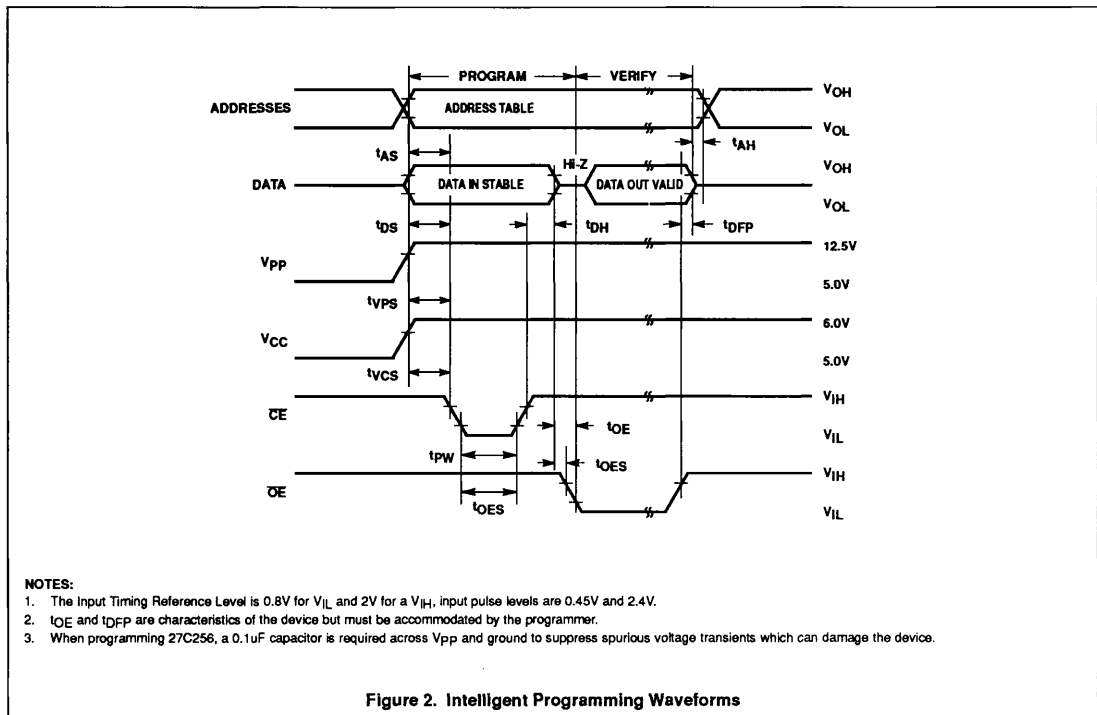


Figure 2. Intelligent Programming Waveforms